2.5 V / 3.3 V Differential 2:1 Clock IN to Differential LVPECL Clock Generator / Divider / Fan-Out Buffer

Multi-Level Inputs w/ Internal Termination

The NB4L339 is a multi-function Clock generator featuring a 2:1 Clock multiplexer front end and simultaneously outputs a selection of four different divide ratios from its four divider blocks; $\pm 1/\pm 2/\pm 4/\pm 8$. One divide block has a choice of ± 1 or ± 2 .

The output of each divider block is fanned-out to two identical differential LVPECL copies of the selected clock. All outputs provide standard LVPECL voltage levels when externally terminated with a 50-ohm resistor to V_{CC} – 2 V.

The differential Clock inputs incorporate internal 50– Ω termination resistors and will accept LVPECL, CML or LVDS logic levels.

The common Output Enable pin (\overline{EN}) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip–flop is clocked on the falling edge of the input clock. Therefore, all associated specification limits are referenced to the negative edge of the clock input.

This device is housed in a 5x5 mm 32 pin QFN package.

Features

- Maximum Input/Output Clock Frequency > 700 MHz
- Low Skew LVPECL Outputs, 15 ps typical
- 1 ns Typical Propagation Delay
- 150 ps Typical Rise and Fall Times
- 0.15 ps Typical RMS Phase Jitter
- 0.5 ps Typical RMS Random Clock Period Jitter
- LVPECL, CML or LVDS Input Compatible
- Operating Range: $V_{CC} = 2.375$ V to 3.6 V with $V_{EE} = 0$ V
- LVPECL Output Level; 750 mV Peak-to-Peak, Typical
- Internal 50– Ω Input Termination Provided
- Synchronous Output Enable/Disable
- Asynchronous Master Reset
- Functionally Compatible with Existing 2.5 V / 3.3 V LVEL, LVEP, EP, and SG Devices
- -40°C to 85°C Ambient Operating Temperature
- 32-Pin QFN, 5 mm x 5 mm
- This is a Pb-Free Device



ON Semiconductor®

http://onsemi.com





Figure 1. Simplified Block Diagram

ORDERING INFORMATION

See detailed ordering and shipping information on page 11 of this data sheet.

Semiconductor Components Industries, LLC, 2012
September, 2012 – Rev. 3



Figure 2. Detailed Logic Diagram

Table 1. Input Select Function Table

CLKSEL*	CLK Input Selected
0	CLKA
1	CLKB

Table 3. Clock Enable/Disable Function Table

X (Don't Care)

EN* **CLK Input MR**** Function Divide - Outputs Active Low to High Transition 0 Н н Hold Q - Outputs Inactive High to Low Transition 1

X (Don't Care)

* Pin will default LOW when left OPEN.

** Pin will default HIGH when left OPEN.

L



Figure 3. Pinout QFN-32 (Top View)

Table 2. Divider Select Function Table

DIVSEL*	QA Divide
0	Divide by 1
1	Divide by 2

Reset Q

Table 4. Pin Description

Pin	Name	I/O	Description	
1, 8, EP	V_{EE}	_	Negative Supply Voltage	
2	CLKA	LVPECL, CML, LVDS Input	Non-inverted differential input (A). (Note 1)	
3	VTA	-	Internal 100– Ω center–tapped termination pin for CLKA and $\overline{\text{CLKA}}$ (Note 1).	
4	CLKA	LVPECL, CML, LVDS Input	Inverted differential input (A). (Note 1)	
5	CLKB	LVPECL, CML, LVDS Input	Non-inverted differential input (B). (Note 1)	
6	VTB	_	Internal 100– Ω center–tapped termination pin for CLKB and $\overline{\text{CLKB}}$. (Note 1)	
7	CLKB	LVPECL, CML, LVDS Input	Inverted differential input (B). (Note 1)	
9, 16, 25, 32	V _{CC}	-	Positive Supply Voltage	
10	CLKSEL	LVCMOS/LVTTL	Asynchronous Clock input select pin. This pin defaults LOW when left open with 80 $k\Omega$ resistor to $V_{\mbox{\scriptsize EE}}.$	
11	QD1	LVPECL Output	Inverted differential (D1) output. Typically terminated with 50 Ω resistor to V_{CC}-2 V	
12	QD1	LVPECL Output	Non–inverted Differential (D1) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
13	QD0	LVPECL Output	Inverted differential (D0) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
14	QD0	LVPECL Output	Non–inverted Differential (D0) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
15	EN	LVCMOS/LVTTL	Synchronous Output Enable/Disable pin. This pin defaults LOW when left open with 80 $k\Omega$ resistor to $V_{\mbox{\scriptsize EE}}.$	
17	QC1	LVPECL Output	Inverted differential (C1) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
18	QC1	LVPECL Output	Non–inverted Differential (C1) Output. Typically terminated with 50 Ω resistor to V_{CC} –	
19	QC0	LVPECL Output	Inverted differential (C0) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
20	QC0	LVPECL Output	Non-inverted Differential (C0) Output. Typically terminated with 50 Ω resistor to V_{CC} -	
21	QB1	LVPECL Output	Inverted differential (B1) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
22	QB1	LVPECL Output	Non–inverted Differential (B1) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
23	QB0	LVPECL Output	Inverted differential (B0) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
24	QB0	LVPECL Output	Non–inverted Differential (B0) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
26	MR	LVCMOS/LVTTL	Master Reset Asynchronous. This pin defaults HIGH when left open with 80 k Ω resistor to $V_{CC}.$	
27	QA1	LVPECL Output	Inverted differential (A1) output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
28	QA1	LVPECL Output	Non–inverted Differential (A1) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
29	QA0	LVPECL Output	Inverted differential (A0) output. Typically terminated with 50 Ω resistor to V_{CC} - 2 V.	
30	QA0	LVPECL Output	Non–inverted Differential (A0) Output. Typically terminated with 50 Ω resistor to V _{CC} – 2 V.	
31	DIVSEL	LVCMOS/LVTTL	Asynchronous Divide Select Pin selects A divide block outputs to divide by 1 or divide by 2. Defaults LOW when left open, divide-by-1, with 80 k Ω resistor to V _{EE} .	
-	EP	_	Exposed Pad. The exposed pad (EP) on package bottom (see case drawing) is thermally connected to the die for improved heat transfer out of package and must be attached to a heat-sinking conduit. The pad is electrically connected to V_{EE} and must be connected to V_{EE} on the PC board.	

 In the differential configuration when the input termination pin (VTx / VTx) are connected to a common termination voltage or left open, and if no signal is applied on CLKx / CLKx input then the device will be susceptible to self–oscillation.

Table 5. ATTRIBUTES

Characterist	Value				
Input Default State Resistors		80 kΩ			
ESD Protection	Human Body Model Machine Model	> 2.0 kV > 100 V			
Moisture Sensitivity (Note 2)	QFN-32	Level 1			
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in			
Transistor Count	366				
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test					

2. For additional information, see Application Note AND8003/D.

Table 6. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	Positive Power Supply	V _{EE} = 0 V		4.0	V
V _{IO}	Input/Output Voltage	V _{EE} = 0 V	$-0.5 = V_{lo} \le V_{CC} + 0.5$	4.0	V
V _{INPP}	Differential Input Voltage Swing CLK - CLK			2.8	V
I _{IN}	Input Current Through R_T (50 Ω Resistor)	Static Surge		45 80	mA
I _{OUT}	Output Current	Continuous Surge		50 100	mA
T _A	Operating Temperature Range	QFN-32		-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 3)	0 LFPM 500 LFPM	QFN-32 QFN-32	31 27	°C/W
θJC	Thermal Resistance (Junction-to-Case)	(Note 3)	QFN-32	12	°C/W
T _{sol}	Wave Solder (Pb-Free)			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

3. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

.....

Symbol	Characteristic	Min	Тур	Max	Unit
I _{EE}	Power Supply Current (Inputs and Outputs Open)	58	70	90	mA
	Dutputs (Note 4)				-
V _{OH}	Output HIGH Voltage \$\$V_{CC} = 3.3 V \$\$V_{CC} = 2.5 V\$\$	V _{CC} - 1135 2155 1355	V _{CC} - 1020 2280 1480	V _{CC} – 760 2540 1740	mV
V _{OL}	Output LOW Voltage \$\$V_{CC} = 3.3 V\$\$V_{CC} = 2.5 V\$\$	V _{CC} – 1935 1355 555	V _{CC} – 1770 1530 730	V _{CC} – 1560 1740 940	mV
Differentia	al Input Driven Single-Ended (see Figures 6 & 8)				
Vth	Input Threshold Reference Voltage Range (Note 6)	1125		V _{CC} – 75	mV
V _{IH}	Single-ended Input HIGH Voltage	Vth + 75		V _{CC}	mV
V _{IL}	Single-ended Input LOW Voltage	V_{EE}		Vth – 75	mV
V _{ISE}	Single-ended Input Voltage ($V_{IH -} V_{IL}$)	150		2800	mV
Differentia	al Inputs Driven Differentially (see Figures 7 & 9)				
V _{IHD}	Differential Input HIGH Voltage	1200		V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage	V_{EE}		V _{CC} – 150	mV
V _{CMR}	Input Common Mode Range (Differential Configuration) (Note 8)	1125		V _{CC} – 75	mV
V _{ID}	Differential Input Voltage Swing (V _{IHD -} V _{ILD})	150		2800	mV
I _{IH}	Input HIGH Current CLKx / CLKx (VTx Open)	10		40	μA
IIL	Input LOW Current CLKx / CLKx (VTx Open)	-10		10	μA
Single–Er	Ided LVCMOS / LVTTL Control Inputs				
V _{IH}	Single-ended Input HIGH Voltage	2000		V _{CC}	mV
VIL	Single-ended Input LOW Voltage	V _{EE}		800	mV
IIH	Input HIGH Current CLKSEL, DIVSEL, EN MR	40 -10		115 10	μA
I _{IL}	Input LOW Current CLKSEL, DIVSEL, EN MR	-10 -115		10 -40	μA
Fermination	on Resistors				
R _{TIN}	Internal Input Termination Resistor (Measured across CLKx and CLKx)	80	100	120	Ω
R _{TIN}	Internal Input Termination Resistor (Measured from CLKx to VTx)	40	50	60	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. LVPECL outputs require 50 Ω receiver termination resistors to V_{CC} – 2 V for proper operation. 5. Input and output parameters vary 1:1 with V_{CC}. 6. Vth is applied to the complementary input when operating in single–ended mode. 7. V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously. 8. V_{CMR} min varies 1:1 with V_{EE}, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the most positive side of the differential input signal.

		−40°C			25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
fin _{max}	Maximum Input CLOCK Frequency	700			700			700			MHz
V _{OUTPP}	Output Voltage Amplitude (@ V _{INPPmin}) (See Figure 4) $f_{in} \le 622 \text{ MHz}$	530	730		530	730		530	730		mV
t _{PLH} , t _{PHL}	Propagation Delay to Output Differential ÷ 1 CLKx/CLKx to Qx/Qx MR to Qx CLKSEL to Qx	0.8 1.2 0.8	1.0 _ 1.0	1.3 5.0 1.3	0.8 1.2 0.8	1.0 - 1.0	1.3 5.0 1.3	0.8 1.2 0.8	1.0 _ 1.0	1.3 5.0 1.3	ns
trr	Reset Recovery	4.0			4.0			4.0			ns
DCO	Output CLOCK Duty Cycle All Divides	40		60	40		60	40		60	%
t _{SKEW}	Within Device Skew (Note 11) Device to Device Skew (Note 12)		30 90	60 190		30 90	60 190		30 90	60 190	ps
t _s	Setup Time @ 50 MHz EN to CLKx DIVSEL to CLKx	900 -100			900 -100			900 -100			ps
t _h	Hold Time @ 50 MHz CLKx to EN CLKx to DIVSEL	800 0			800 0			800 0			ps
t _{PW}	Minimum Pulse Width MR	5.0			5.0			5.0			ns
Φ _N	Phase Noise f _{in} = 622.08 MHz Outputs (A) Div by 1 10 kHz 100 kHz 100 HZ 100 HHz 20 MHz 40 MHz					-136 -136 -141 -141 -141 -141					dBc
tJIT1	Integrated Phase Jitter (Figure 4) f _{in} = 622.08 MHz, 12 kHz – 20 MHz Offset All Divides		0.15	0.25		0.15	0.25		0.15	0.25	ps RMS
t _{JIT2}	Random Clock Period Jitter (Note 13) f _{in} = 622.08 MHz All Divides		0.5	1.5		0.5	1.5		0.5	1.5	ps RMS
V _{INPP}	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 14)	150			150			150			mV
t _r , t _f	Output Rise/Fall Times @ 622.08 MHz input frequency (20% – 80%)		150	250		150	250		150	250	ps

Table 8. AC CHARACTERISTICS $V_{CC} = 2.375 \text{ V to } 3.6 \text{ V}, V_{EE} = 0 \text{ V}$ (Note 9)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

 Measured by forcing V_{INPP} (Min) from a 50% duty cycle clock source. All loading with an external R_L = 50 Ω to V_{CC} – 2 V Input edge rates 100 ps (20% – 80%).

10 Duty cycle skew is measured between differential outputs using the deviations of the sum of Tpw- and Tpw+ @ 50 MHz.

11. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross-point of the inputs to the cross-point of the outputs.

12. Device to device skew is measured between outputs under identical transition @ 50 MHz.

13. Additive RMS jitter with 50% duty cycle clock signal; all inputs and outputs active.

14. VINPP (Max) cannot exceed V_{CC} - V_{EE}. Input voltage swing is a single-ended measurement operating in differential mode.



Figure 4. NB4L339 vs. Agilent 8665A 622.08 MHz at 3.3 V, Room Ambient



Figure 5. Output Voltage Amplitude (V_{OUTPP}) vs. Input Clock Frequency (f_{in}) at Ambient Temperature (Typical)

Application Information

The NB4L339 is a high–speed, Clock multiplexer, divider and low skew fan–out buffer featuring a 2:1 Clock multiplexer front end and outputs a selection of four different divide ratios; $\pm 1/2/4/8$. One divide block has a choice of ± 1 or ± 2 . The outputs of all four divider blocks are fanned–out to two pair of identical differential LVPECL copies of the selected clock. All outputs provide standard LVPECL voltage levels when externally terminated with a 50–ohm resistor to V_{TT} = V_{CC} – 2 V.

The differential Clock input buffers incorporate internal 50– Ω termination resistors in a 100– Ω center–tapped configuration and are accessible via a VTx pin. This feature provides transmission line termination on–chip, at the receiver end, eliminating external components. Inputs CLKA/B and CLKA/B must be signal driven or auto oscillation may result.

The NB4L339 Clock inputs can be driven by a variety of differential signal level technologies including LVDS, LVPECL, or CML.

The internal dividers are synchronous to each other. Therefore, the common output edges are precisely aligned.

The Output Enable pin (\overline{EN}) is synchronous so that the internal divider flip-flops will only be enabled/disabled when the internal clock is in the LOW state. This avoids any chance of generating a runt pulse on the internal clock when the device is enabled/disabled, as can happen with an asynchronous control. The internal enable flip-flop is clocked on the falling edge of the input clock. Therefore, all associated specification limits are referenced to the negative edge of the clock input.

The Master Reset (\overline{MR}) is asynchronous. When \overline{MR} is forced LOW, all Q outputs go to logic LOW.





The $\overline{\text{EN}}$ signal will "freeze" the internal divider flip-flops on the first falling edge of CLK after its assertion. The internal divider flip-flops will maintain their state during the freeze. When $\overline{\text{EN}}$ is deasserted (LOW), and after the next falling edge of CLK, then the internal divider flip–flops will "unfreeze" and continue to their next state count with proper phase relationships.







Figure 10. Differential Input Driven Single-Ended











Figure 17. LVDS Interface



Figure 18. Standard 50 Ω Load CML Interface





*V_{REFAC} bypassed to ground with a 0.01 μ F capacitor.







Figure 21. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices)

ORDERING INFORMATION

Device	Package	Shipping [†]
NB4L339MNG	QFN32 (Pb-free)	74 Units / Tray
NB4L339MNR4G	QFN32 (Pb-free)	1000 / Tape & Reel

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS



NOTES:

1.

DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED 2 З.

TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM TERMINAL COPLANARITY APPLIES TO THE EXPOSED

PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	0.800	0.900	1.000			
A1	0.000	0.025	0.050			
A3	0.	200 REI	F			
b	0.180	0.250	0.300			
D	5.	00 BSC				
D2	2.950	950 3.100				
Ε	5.	.00 BSC				
E2	2.950	3.100	3.250			
е	0.500 BSC					
К	0.200					
L	0.300	0.400	0.500			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ScILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ScILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights on the rights of others. SCILLC products are not designed, intended, or authorized for used as components in systems intended for surption to resten in the body or other applications intended to surption or surption. surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative